



2827

AMENDMENT TRANSMITTAL LETTERDocket No.
M4065.0226/P226Application No.
09/484,437-Conf. #9698Filing Date
January 18, 2000Examiner
J. MitchellArt Unit
2827

Applicant(s): Tongbi Jiang

Invention: DIE ATTACH CURING METHOD FOR BGA PRODUCT

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

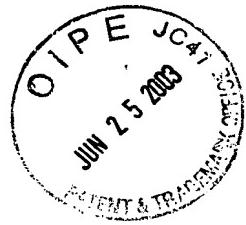
| CLAIMS AS AMENDED | | | | | |
|--|----------------------------------|--------------------------------|-----------------------------|--------|------|
| | Claims Remaining After Amendment | Highest Number Previously Paid | Number Extra Claims Present | Rate | |
| Total Claims | 24 | - 30 = | 0 | x 0.00 | 0.00 |
| Independent Claims | 2 | - 3 = | 0 | x 0.00 | 0.00 |
| Multiple Dependent Claims (check if applicable) <input type="checkbox"/> | | | | | |
| Other fee (please specify): | | | | | |
| TOTAL ADDITIONAL FEE FOR THIS AMENDMENT: | | | | | 0.00 |

 Large Entity Small Entity No additional fee is required for this amendment. Please charge Deposit Account No. _____ in the amount of \$ _____. A duplicate copy of this sheet is enclosed. A check in the amount of \$ _____ to cover the filing fee is enclosed. Payment by credit card. Form PTO-2038 is attached. The Director is hereby authorized to charge and credit Deposit Account No. 04-1073 as described below. A duplicate copy of this sheet is enclosed. Credit any overpayment. Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.

Dated: June 25, 2003


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Docket No.: M4065.0226/P226
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Tongbi Jiang

Application No.: 09/484,437

Group Art Unit: 2827

Filed: January 18, 2000

Examiner: J. Mitchell

For: DIE ATTACH CURING METHOD FOR
BGA PRODUCT

AMENDMENT

Box Non-Fee Amendment
Commissioner for Patents
Washington, DC 20231

Dear Sir:

In response to the Office Action dated April 2, 2003 (Paper No. 328), please amend the above-identified U.S. patent application as shown in the Section marked "Amendment to Claims".